# MP8774



12A, Wide Input 3V-18V, 700kHz Synchronous Step-down Converter with PG and External Soft Start in 3x3mm QFN package

# **DESCRIPTION**

The MP8774 is a fully integrated high-frequency, synchronous, rectified, step-down, switch-mode converter with internal power MOSFETs. The MP8874 offers a very compact solution that achieves 12A of continuous output current with excellent load and line regulation over a wide input range. The MP8774 uses synchronous mode operation for higher efficiency over the output current load range.

Constant-on-time (COT) control operation provides very fast transient response, easy loop design, and very tight output regulation.

Full protection features include short-circuit protection (SCP), over-current protection (OCP), under-voltage protection (UVP), and thermal shutdown.

The MP8774 requires a minimal number of readily available. standard. components and is available in a space-saving QFN-16 (3mmx3mm) package.

# **FEATURES**

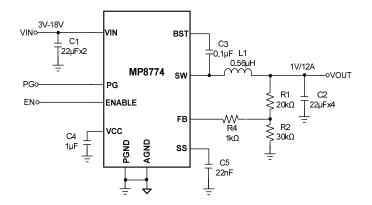
- Output Adjustable from 0.6V
- Wide 3V to 18V Operating Input Range
- 12A Output Current
- $16m\Omega/5.5m\Omega$  Low R<sub>DS(ON)</sub> Internal Power **MOSFETs**
- 100µA Quiescent Current
- High-Efficiency Synchronous Mode
- Pre-Biased Start-Up
- Fixed 700kHz Switching Frequency
- External Programmable Soft Start-Up Time
- Enable (EN) and Power Good (PG) for Power Sequencing
- Over-Current Protection (OCP) and Hiccup
- Thermal Shutdown
- Available in a QFN-16 (3mmx3mm) Package

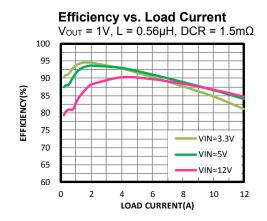
# **APPLICATIONS**

- **Security Cameras**
- Portable Devices, XDSL Devices
- Digital Set-Top Boxes
- Flat-Panel Television and Monitors
- General Purpose

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# TYPICAL APPLICATION







# ORDERING INFORMATION

Part Number*	Package	Top Marking
MP8774GQ	QFN-16 (3mmx3mm)	See Below

<sup>\*</sup> For Tape & Reel, add suffix –Z (e.g.: MP8774GQ–Z)

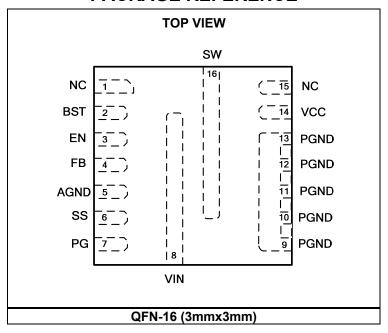
# **TOP MARKING**

BAQY LLL

BAQ: Product code of MP8774GQ

Y: Year code LLL: Lot number

# **PACKAGE REFERENCE**





Thermal Resistance	$oldsymbol{ heta}_{JA}$	$\boldsymbol{\theta}_{JC}$	
QFN-16 (3mmx3mm)			
EV8774-Q-00A <sup>(4)</sup>	. 38	10	.°C/W
JESD51-7 <sup>(5)</sup>	. 50	12	.°C/W

### NOTES:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub> (MAX), the junction-to-ambient thermal resistance θ<sub>JA</sub>, and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P<sub>D</sub> (MAX) = (T<sub>J</sub> (MAX)-T<sub>A</sub>)/θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation produces an excessive die temperature, causing the regulator to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on EV8774-Q-00A, 4-layer PCB.
- 5) The value of θ<sub>JA</sub> given in this table is only valid for comparison with other packages and cannot be used for design purposes. These values were calculated in accordance with JESD51-7, and simulated on a specified JEDEC board. They do not represent the performance obtained in an actual application.



# **ELECTRICAL CHARACTERISTICS** (6)

 $V_{IN}$  = 12V,  $T_J$  = -40°C to +125°C, typical value is tested at  $T_J$  = +25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units	
Input voltage range	V <sub>IN</sub>		3		18	V	
Supply Current	•			•	ı	•	
Supply current (shutdown)	I <sub>IN</sub>	V <sub>EN</sub> = 0V			5	μA	
Supply current (quiescent)	ΙQ	V <sub>EN</sub> = 2V, V <sub>FB</sub> = 0.65V		100	150	μΑ	
MOSFET	•			•	•		
HS switch on resistance	HS <sub>RDS(ON)</sub>	V <sub>BST-SW</sub> = 3.3V		16		mΩ	
LS switch on resistance	LS <sub>RDS(ON)</sub>	V <sub>CC</sub> = 3.3V		5.5		mΩ	
Switch leakage	SWLKG	V <sub>EN</sub> = 0V, V <sub>SW</sub> = 17V, T <sub>J</sub> = 25°C			1	μΑ	
Current Limit and ZCD							
Valley current limit	ILIMIT_VY		12	14		Α	
Short hiccup duty cycle (7)	DHICCUP			10		%	
ZCD	Izcd			200		mA	
Switching Frequency and	Minimum Or	n/Off Timer		•	•		
Switching frequency	Fs		600	700	800	kHz	
Minimum on time (7)	T <sub>On MIN</sub>			50		ns	
Minimum off time (7)	T <sub>Off MIN</sub>			100		ns	
Reference and Soft Start							
Coodbook voltono	\ \/	T <sub>J</sub> = 25°C	594	600	606	\ /	
Feedback voltage	V <sub>FB</sub>	T <sub>J</sub> = -40°C to +125°C	591	600	609	— m\/	
Feedback current	I <sub>FB</sub>	V <sub>FB</sub> = 700mV		10	50	nA	
Soft-start current	I <sub>SS_START</sub>		4	6	8	μΑ	
Enable and UVLO							
EN rising threshold	V <sub>EN RISING</sub>		1.1	1.25	1.4	V	
EN falling threshold	V <sub>EN</sub> FALLING		0.9	1	1.1	V	
EN pull-down resistor	R <sub>EN_PD</sub>			1.2		ΜΩ	
VCC							
VCC under-voltage lockout threshold rising	VCC <sub>Vth</sub>		2.6	2.8	3	V	
VCC under-voltage lockout threshold	VCCHYS			350		mV	
VCC regulator	Vcc			3.4		V	
VCC load regulation	Regvcc	I <sub>CC</sub> = 5mA		3		%	



ELECTRICAL CHARACTERISTICS  $^{(6)}$  (continued)  $V_{IN}$  = 12V,  $T_J$  = -40°C to +125°C, typical value is tested at  $T_J$  = +25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Good						
Power good UV rising threshold	PGUV <sub>vth_Hi</sub>		0.85	0.9	0.95	V <sub>FB</sub>
Power good UV falling threshold	PGUV <sub>vth_Lo</sub>		0.75	0.80	0.85	V <sub>FB</sub>
Power good OV rising threshold	PGOV <sub>vth_Hi</sub>		1.15	1.2	1.25	V <sub>FB</sub>
Power good OV falling threshold	PGOV <sub>vth_Lo</sub>		1.05	1.1	1.15	V <sub>FB</sub>
Power good delay	PG <sub>Td</sub>	Both edge		50		μs
Power good sink current capability	$V_{PG}$	Sink 4mA			0.4	V
Power good leakage current	I <sub>PG_LEAK</sub>	V <sub>PG</sub> = 5V			10	μΑ
Thermal Protection						
Thermal shutdown (7)	T <sub>SD</sub>			150		°C
Thermal hysteresis (7)	T <sub>SD-HYS</sub>			20		°C

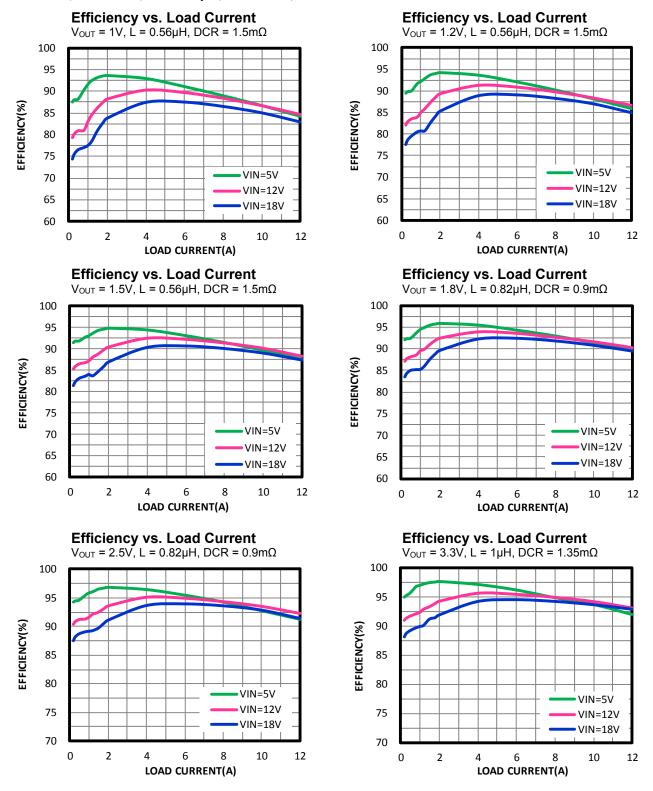
## NOTES:

Guaranteed by over-temperature correlation, not tested in production.

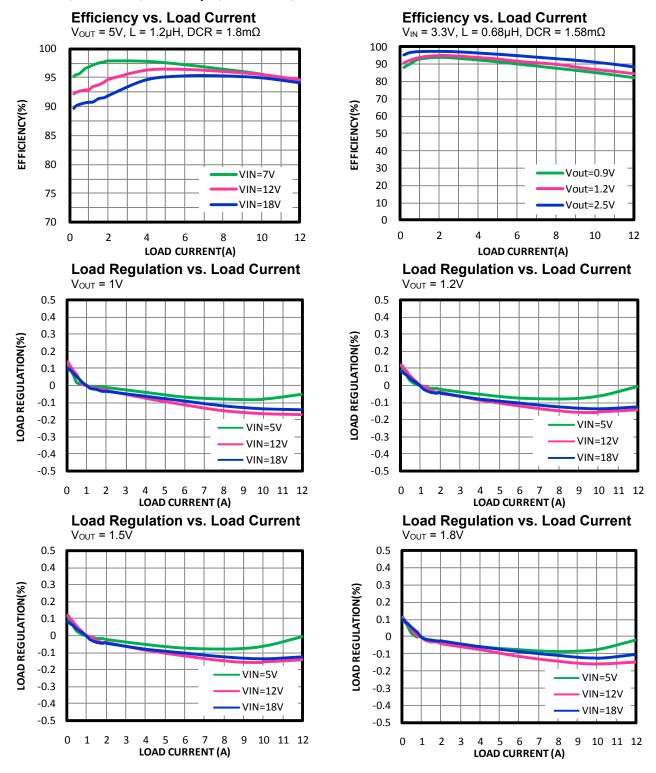
Guaranteed by design and characterization test.



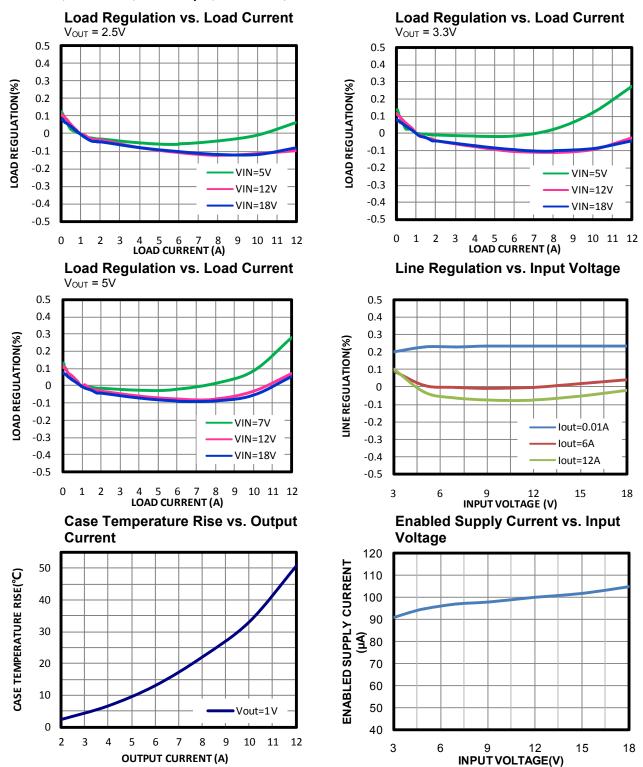
# TYPICAL PERFORMANCE CHARACTERISTICS







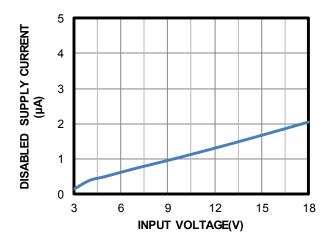




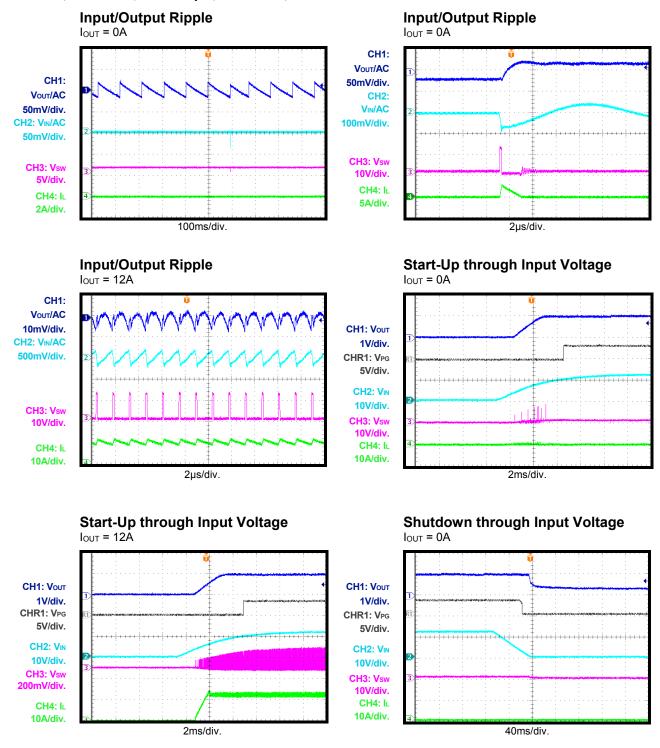


 $V_{IN}$  = 12V,  $V_{OUT}$  = 1V, L = 0.56 $\mu$ H,  $T_A$  = 25°C, unless otherwise noted.

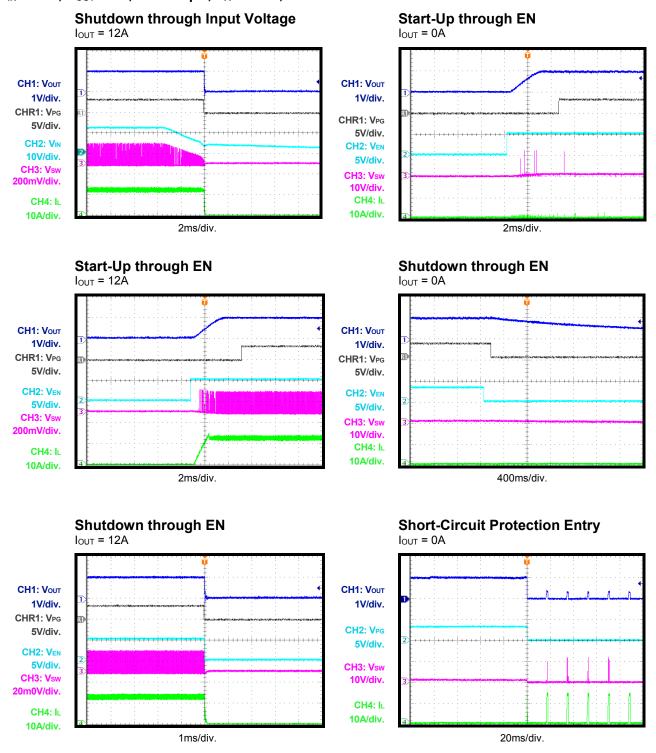
Disabled Supply Current vs. Input Voltage













10A/div.

# TYPICAL PERFORMANCE CHARACTERISTICS (continued)

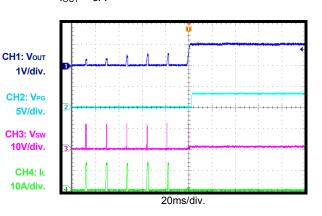
 $V_{IN}$  = 12V,  $V_{OUT}$  = 1V, L = 0.56 $\mu$ H,  $T_A$  = 25°C, unless otherwise noted.

# State Short output to GND CH1: Vour 1V/div. CH2: VPG 5V/div. CH3: Vsw 10V/div. CH4: IL

20ms/div.

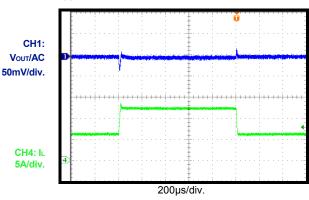
**Short-Circuit Protection Steady** 

# **Short-Circuit Protection Recovery** $I_{OUT} = 0A$



## **Load Transient**







# **PIN FUNCTIONS**

Package Pin #	Name	Description			
1, 15	NC	No connection. NC must be left floating.			
2	BST	<b>Bootstrap.</b> Connect a capacitor between SW and BST to form a floating supply across the high-side switch driver. A BST resistor less than $4.7\Omega$ is recommended.			
3	EN	<b>Enable.</b> Pull EN high to enable the MP8774. When floating, EN is pulled down to GND and disabled by an internal $1.2M\Omega$ resistor.			
4	FB	<b>Feedback.</b> FB sets the output voltage when connected to the tap of an external resistor divider between output and GND.			
5	AGND	<b>Signal ground.</b> AGND is not connected to the system ground internally. Ensure that AGND is connected to the system ground in the PCB layout.			
6	SS	<b>Soft start.</b> Connect a capacitor across SS and GND to set the soft-start time to avoid inrush current at start-up.			
7	PG	<b>Power good output.</b> The output of PG is an open drain. PG changes state if UVP, OCP, OTP, or OV occurs.			
8	VIN	<b>Supply voltage.</b> The MP8774 operates from a 3 - 18V input rail. A capacitor (C1) is needed to decouple the input rail. Use a wide PCB trace to make the connection.			
9 - 13	PGND	<b>System ground.</b> PGND is the reference ground of the regulated output voltage. PGND requires careful consideration during the PCB layout. PGND is recommended to be connected to GND with coppers and vias.			
14	VCC	Internal bias supply output. Decouple VCC with a $1\mu F$ capacitor. Place the VCC capacitor close to VCC and GND.			
16	SW	Switch output. Connect SW with a wide PCB trace.			



# **BLOCK DIAGRAM**

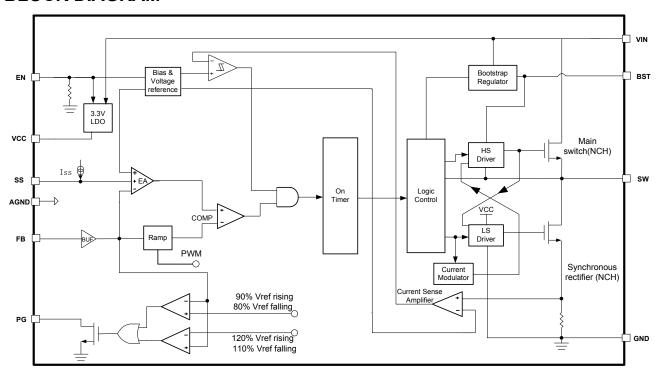


Figure 1: Functional Block Diagram



# **OPERATION**

The MP8774 is a fully integrated, synchronous, rectified, step-down, switch-mode converter. Constant-on-time (COT) control is employed to provide fast transient response and ease loop stabilization. Figure 2 shows the simplified ramp compensation block in the MP8774. At the beginning of each cycle, the high-side MOSFET (HS-FET) is turned on when the feedback voltage ( $V_{FB}$ ) is below the reference voltage ( $V_{REF}$ ), which indicates an insufficient output voltage. The on period is determined by both the output voltage and input voltage to make the switching frequency fairly constant over the input voltage range.

After the on period elapses, the HS-FET is turned off. The HS-FET is turned on again when  $V_{\text{FB}}$  drops below  $V_{\text{REF}}$ . By repeating operation in this way, the converter regulates the output voltage. The integrated low-side MOSFET (LS-FET) is turned on when the HS-FET is in its off state to minimize conduction loss. There is a dead short between the input and GND if both the HS-FET and LS-FET are turned on at the same time. This is called shoot-through. To avoid shoot-through, a dead time (DT) is generated internally between the HS-FET off and LS-FET on period or the LS-FET off and HS-FET on period.

Internal compensation is applied for COT control to provide a more stable operation, even when ceramic capacitors are used as output capacitors. This internal compensation improves jitter performance without affecting the line or load regulation.

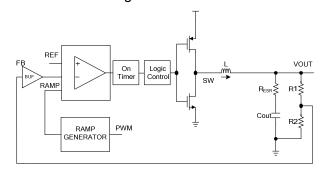


Figure 2: Simplified Ramp Compensation Block

# **Heavy-Load Operation**

Continuous conduction mode (CCM) is when the output current is high and the inductor current is always above zero amps (see Figure 3). When  $V_{FB}$  is below the error amplifier output voltage ( $V_{EAO}$ ), the HS-FET is turned on for a fixed interval determined by the one-shot on-timer. When the HS-FET is turned off, the LS-FET is turned on until the next period.

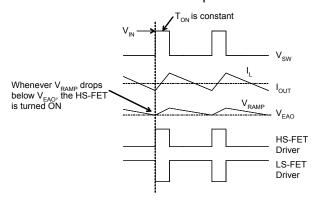


Figure 3: Heavy-Load Operation

In CCM operation, the switching frequency is fairly constant. This is called pulse-width modulation (PWM) mode.

# **Light-Load Operation**

When the MP8774 works in pulse-frequency modulation (PFM) during light-load operation, the MP8774 reduces the switching frequency automatically to maintain high efficiency, and the inductor current drops almost to zero. When the inductor current reaches zero, the LS-FET driver goes into tri-state (Hi-Z) (see Figure 4). Therefore, the output capacitors discharge slowly to GND through the LS-FET, R1, and R2. This operation improves device efficiency greatly when the output current is low.

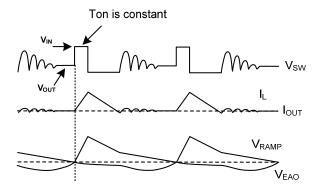


Figure 4: Light-Load Operation



Light-load operation is also called skip mode because the HS-FET does not turn on as frequently as it does during heavy-load conditions. The HS-FET turn-on frequency is a function of the output current. As the output current increases, the current modulator regulation time period becomes shorter, and the HS-FET turns on more frequently. The switching frequency increases in turn. The output current reaches the critical level when the current modulator time is zero and can be determined with Equation (1):

$$I_{\text{OUT}} = \frac{(V_{\text{IN}} - V_{\text{OUT}}) \times V_{\text{OUT}}}{2 \times L \times F_{\text{SW}} \times V_{\text{IN}}}$$
(1)

The device reverts to PWM mode once the output current exceeds the critical level. Afterward, the switching frequency remains fairly constant over the output current range.

# **VCC Regulator**

The 3.4V internal regulator power most of the internal circuitries. This regulator takes the  $V_{IN}$  input and operates in the full  $V_{IN}$  range. When  $V_{IN}$  exceeds 3.4V, the output of the regulator is in full regulation. When  $V_{IN}$  falls below 3.4V, the output of the regulator decreases following  $V_{IN}$ . A 1 $\mu$ F decoupling ceramic capacitor is needed at VCC.

# Enable (EN)

EN is a digital control pin that turns the regulator on and off. Drive EN above 1.25V to turn on the regulator. Drive EN below 1V to turn off the regulator. When floating, EN is pulled down to GND by an internal 1.2M $\Omega$  resistor. EN can be connected to  $V_{IN}$  directly and supports a 18V input range.

## **Under-Voltage Lockout (UVLO)**

Under-voltage lockout (UVLO) protects the chip from operating at an insufficient supply voltage. The MP8774 UVLO comparator monitors the output voltage of the internal regulator (VCC). The VCC UVLO rising threshold is about 2.8V, while its falling threshold is 2.45V.

When the input voltage is higher than the UVLO rising threshold voltage, the MP8774 powers up. The MP8774 shuts off when the input voltage is lower than the UVLO falling threshold voltage. This is a non-latch protection.

# Soft Start (SS)

The MP8774 employs a soft start (SS) mechanism to ensure smooth output ramping during power-up. When EN goes high, an internal current source (6 $\mu$ A) charges up the SS capacitor. The SS capacitor voltage takes over V<sub>REF</sub> to the PWM comparator. The output voltage ramps up smoothly with the SS voltage (V<sub>SS</sub>). Once V<sub>SS</sub> rises above V<sub>REF</sub>, it continues to ramp up until V<sub>REF</sub> takes over. At this point, the soft start finishes, and the device enters steady-state operation.

The SS capacitor value can be determined with Equation (2):

$$C_{ss}(nF) = 0.83 \times \frac{T_{ss}(ms) \times I_{ss}(uA)}{V_{REF}(V)}$$
 (2)

If the output capacitance is large, it is not recommended to set the SS time too short; otherwise, the current limit can be reached easily during SS. SS cap less than 4.7nF should be avoid.

# Power Good (PG) Indicator

PG is the open drain of a MOSFET that connects to VCC or another voltage source through a resistor (e.g.:  $100k\Omega$ ). The MOSFET turns on with the application of an input voltage, so PG is pulled to GND before SS is ready. After V<sub>FB</sub> reaches 90% of V<sub>REF</sub>, PG is pulled high after a 50µs delay. When V<sub>FB</sub> drops to 80% of V<sub>REF</sub>, PG is pulled low.

When UVLO or over-temperature protection (OTP) occurs, PG is pulled low immediately. When an over-current (OC) condition occurs, PG is pulled low when  $V_{FB}$  drops below 80% of  $V_{REF}$  after a 0.05ms delay. When an over-voltage (OV) condition occurs, PG is pulled low when  $V_{FB}$  rises above 120% of  $V_{REF}$  after a 0.05ms delay. If  $V_{FB}$  falls below 110% of  $V_{REF}$ , PG is pulled high after a 0.05ms delay.

If the input supply fails to power the MP8774, PG is clamped low, even though PG is tied to an external DC source through a pull-up resistor. The relationship between the PG voltage and the pull-up current is shown in Figure 5.



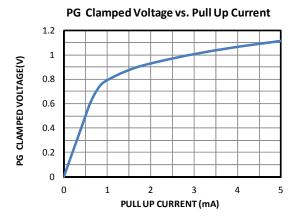


Figure 5: PG Clamped Voltage vs. Pull-Up Current

# Over-Current Protection (OCP) and Short-Circuit Protection (SCP)

The MP8774 has a valley-limit control. The LS-FET monitors the current flowing through the LS-FET. The HS-FET waits until the valley current limit is removed before turning on again. Meanwhile, the output voltage drops until  $V_{FB}$  is below the under-voltage (UV) threshold (typically 50% below the reference). Once UV is triggered, the MP8774 enters hiccup mode to restart the part periodically.

During over-current protection (OCP), the device attempts to recover from the over-current fault with hiccup mode. This means that the chip disables the output power stage, discharges the soft-start capacitor, and attempts to soft start again automatically. If the over-current condition still remains after the soft start ends, the device repeats this operation cycle until the over-current condition disappears, and then the output rises back to the regulation level. OCP is a non-latch protection.

# **Pre-Bias Start-Up**

The MP8774 is designed for monotonic start-up into pre-biased loads. If the output is pre-biased to a certain voltage during start-up, the BST voltage is refreshed and charged, and the voltage on the soft-start capacitor is charged as well. If the BST voltage exceeds its rising threshold voltage and the soft-start capacitor voltage exceeds the sensed output voltage at FB, the part begins working normally.

## **Thermal Shutdown**

Thermal shutdown prevents the chip from operating at exceedingly high temperatures. When the silicon die temperature exceeds 150°C, the entire chip shuts down. When the temperature falls below its lower threshold (typically 130°C), the chip is enabled again.

# Floating Driver and Bootstrap Charging

An external bootstrap capacitor powers the floating power MOSFET driver. This floating driver has its own UVLO protection with a rising threshold of 1.7V and a hysteresis of 150mV.  $V_{\rm IN}$  regulates the bootstrap capacitor voltage internally through D1, M1, R4, C4, Lo, and Co (see Figure 6). If  $V_{\rm IN}$  -  $V_{\rm SW}$  exceeds 5V, U2 regulates M1 to maintain a 3.3V BST voltage across C4. The BST resistor (R4) is recommended to be less than  $4.7\Omega$ .

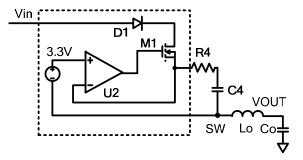


Figure 6: Internal Bootstrap Charger

# Start-Up and Shutdown Circuit

If both  $V_{\text{IN}}$  and EN exceed their respective thresholds, the chip starts up. The reference block starts first, generating a stable reference voltage and current, and then the internal regulator is enabled. The regulator provides a stable supply for the remaining circuits.

Three events can shut down the chip: EN low,  $V_{\text{IN}}$  low, and thermal shutdown. The shutdown procedure starts by blocking the signaling path initially to avoid any fault triggering. The internal supply rail is then pulled down.



# APPLICATION INFORMATION

# **Setting the Output Voltage**

An external resistor divider is used to set the output voltage. First, choose a value for R2. R2 should be chosen reasonably, since a small R2 leads to considerable quiescent current loss, while a large R2 makes FB noise-sensitive. R2 is recommended to between 2 -  $100k\Omega$ . Typically, set the current through R2 to be below  $250\mu\text{A}$  for a good balance between system stability and no-load loss. Then determine R1 with Equation (3):

$$R1 = \frac{V_{OUT} - V_{REF}}{V_{REF}} \times R2$$
 (3)

The feedback circuit is shown in Figure 7.

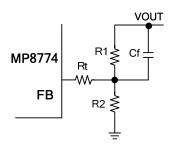


Figure 7: Feedback Network

Table 1 lists the recommended resistor values for common output voltages.

Table 1: Resistor Selection for Common Output Voltages

V <sub>OUT</sub> (V)	R1 (kΩ)	R2 (kΩ)	L (µH)	Cf (pF)	Rt (kΩ)
1.0	20	30	0.56	56	1
1.2	20	20	0.56	56	1
1.5	20	13	0.56	56	1
1.8	20	10	0.82	56	1
2.5	20	6.34	0.82	56	1
3.3	20	4.42	1	56	1
5	20	2.7	1.2	56	1

## Selecting the Inductor

An inductor is necessary for supplying constant current to the output load while being driven by the switched input voltage. A larger-value inductor results in less ripple current and a lower output ripple voltage but also has a larger physical footprint, higher series resistance, and lower saturation current. A good rule for determining the inductance value is to design the peak-to-peak ripple current in the inductor

to be in the range of 30 - 40% of the maximum output current, and ensure that the peak inductor current is below the maximum switch current limit. The inductance value can be calculated with Equation (4):

$$L = \frac{V_{OUT}}{F_{SW} \times \Delta I_L} \times (1 - \frac{V_{OUT}}{V_{IN}})$$
 (4)

Where  $\Delta I_L$  is the peak-to-peak inductor ripple current.

The inductor should not saturate under the maximum inductor peak current, where the peak inductor current can be calculated with Equation (5):

$$I_{LP} = I_{OUT} + \frac{V_{OUT}}{2F_{SW} \times L} \times (1 - \frac{V_{OUT}}{V_{IN}})$$
 (5)

# **Selecting the Input Capacitor**

The input current to the step-down converter is discontinuous and therefore requires a capacitor to supply AC current to the step-down converter while maintaining the DC input voltage. For the best performance, use ceramic capacitors placed as close to VIN as possible. Capacitors with X5R and X7R ceramic dielectrics are recommended because they are fairly stable with temperature fluctuations.

The capacitors must also have a ripple current rating greater than the maximum input ripple current of the converter. The input ripple current can be estimated with Equation (6):

$$I_{CIN} = I_{OUT} \times \sqrt{\frac{V_{OUT}}{V_{IN}} \times (1 - \frac{V_{OUT}}{V_{IN}})}$$
 (6)

The worst-case condition occurs at  $V_{IN} = 2V_{OUT}$ , shown in Equation (7):

$$I_{CIN} = \frac{I_{OUT}}{2} \tag{7}$$

For simplification, choose an input capacitor with an RMS current rating greater than half of the maximum load current.

The input capacitance value determines the input voltage ripple of the converter. If there is an input voltage ripple requirement in the system, choose an input capacitor that meets the specification.



The input voltage ripple can be estimated with Equation (8):

$$\Delta V_{IN} = \frac{I_{OUT}}{F_{SW} \times C_{IN}} \times \frac{V_{OUT}}{V_{IN}} \times (1 - \frac{V_{OUT}}{V_{IN}})$$
 (8)

The worst-case condition occurs at  $V_{IN} = 2V_{OUT}$ , shown in Equation (9):

$$\Delta V_{IN} = \frac{1}{4} \times \frac{I_{OUT}}{F_{SW} \times C_{IN}}$$
 (9)

# **Selecting the Output Capacitor**

An output capacitor is required to maintain the DC output voltage. Ceramic or POSCAP capacitors are recommended. The output voltage ripple can be estimated with Equation

$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{F_{\text{SW}} \times L} \times (1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}) \times (R_{\text{ESR}} + \frac{1}{8 \times F_{\text{SW}} \times C_{\text{OUT}}}) \quad (10)$$

In the case of ceramic capacitors, impedance at the switching frequency is dominated by the capacitance. The output voltage ripple is mainly caused by the capacitance. For simplification, the output voltage ripple can be estimated with Equation (11):

$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{8 \times F_{\text{SW}}^2 \times L \times C_{\text{OUT}}} \times (1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}})$$
 (11)

In the case of POSCAP capacitors, the ESR dominates the impedance at the switching frequency. For simplification, the output ripple can be approximated with Equation (12):

$$\Delta V_{OUT} = \frac{V_{OUT}}{F_{SW} \times L} \times (1 - \frac{V_{OUT}}{V_{IN}}) \times R_{ESR}$$
 (12)

Besides considering the output ripple, choosing a larger output capacitor can also result in a better load transient response. Be sure to consider the maximum output capacitor limitation in the design application. If the output capacitor value is too high, the output voltage cannot reach the design value during the softstart time and fails to regulate.

The maximum output capacitor value (Co max) can be limited approximately with Equation (13):

$$C_{O MAX} = (I_{LIM AVG} - I_{OUT}) \times T_{ss} / V_{OUT}$$
 (13)

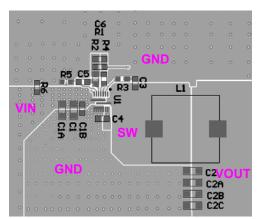
Where I<sub>LIM AVG</sub> is the average start-up current during the soft-start period, and Tss is the softstart time.

# **PCB Layout Guidelines**

Efficient PCB layout of the switching power supplies is critical for stable operation. A poor layout design can result in poor line or load regulation and stability issues. For better performance, it is recommended to use a fourlayer board (two middle layers are GND). For best results, refer to Figure 8 and follow the auidelines below.

- 1. Place the high-current paths (GND, VIN, and SW) very close to the device with short, direct, and wide traces.
- 2. Place the input capacitor as close to VIN and GND as possible.
- 3. Place a VCC decoupling capacitor close to the device.
- 4. Connect AGND and PGND at the point of the VCC capacitor's ground connection.
- 5. Place the external feedback resistors next to FB.
- 6. Keep the switching node (SW) short and away from the feedback network.





Top Layer

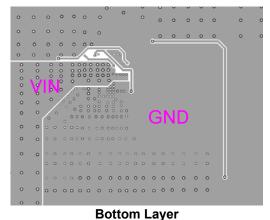


Figure 8: Recommended Layout

# **Design Example**

Table 2 shows a design example when ceramic capacitors are applied.

Table 2: Design Example

V <sub>IN</sub>	12V
Vout	1V
louт	12A

The detailed application schematics are shown in Figure 9 through Figure 15. The typical performance and waveforms are shown in the Typical Characteristics section. For more devices applications, please refer to the related evaluation board datasheet.

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# TYPICAL APPLICATION CIRCUITS

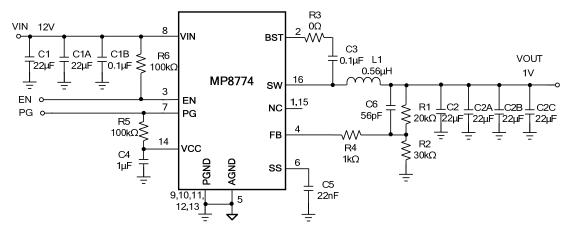


Figure 9:  $V_{IN} = 12V$ ,  $V_{OUT} = 1V$ ,  $I_{OUT} = 12A$  (8)

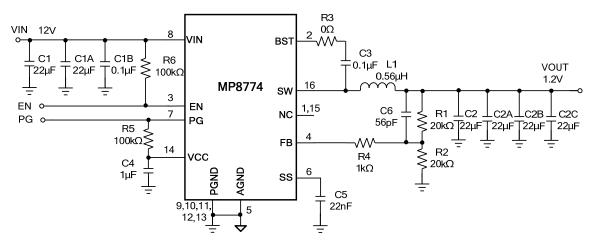


Figure 10:  $V_{IN} = 12V$ ,  $V_{OUT} = 1.2V$ ,  $I_{OUT} = 12A$  (8)

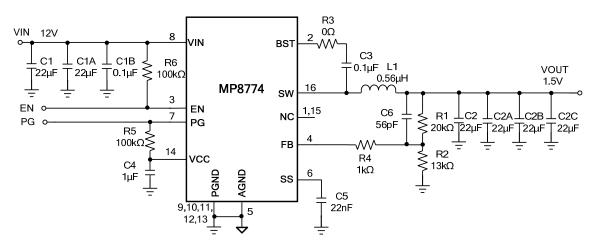


Figure 11:  $V_{IN} = 12V$ ,  $V_{OUT} = 1.5V$ ,  $I_{OUT} = 12A$  (8)



# TYPICAL APPLICATION CIRCUITS (continued)

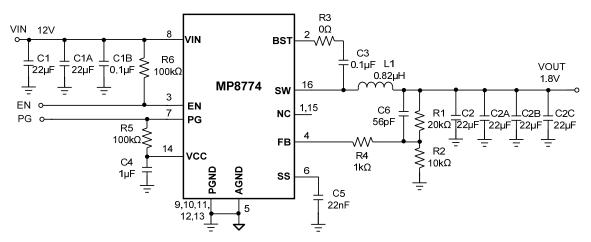


Figure 12:  $V_{IN} = 12V$ ,  $V_{OUT} = 1.8V$ ,  $I_{OUT} = 12A$  (8)

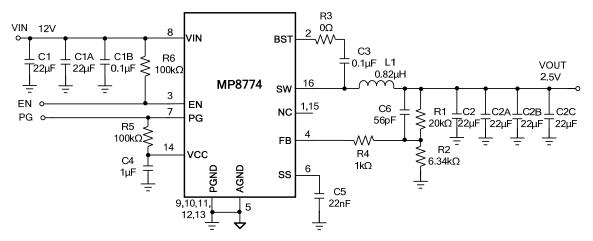


Figure 13:  $V_{IN} = 12V$ ,  $V_{OUT} = 2.5V$ ,  $I_{OUT} = 12A$  (8)

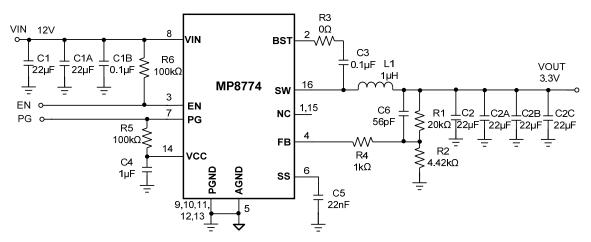


Figure 14:  $V_{IN} = 12V$ ,  $V_{OUT} = 3.3V$ ,  $I_{OUT} = 12A$  (8)



# **TYPICAL APPLICATION CIRCUITS (continued)**

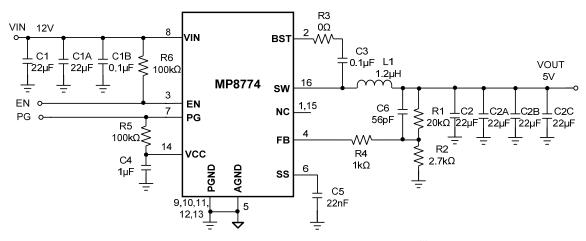


Figure 15:  $V_{IN} = 12V$ ,  $V_{OUT} = 5V$ ,  $I_{OUT} = 12A$  (8)

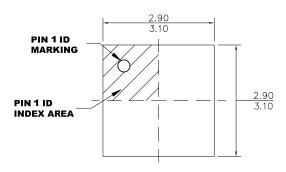
#### NOTE

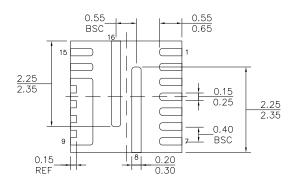
8) When  $V_{\text{IN}}$  is low, refer to the Selecting the Input Capacitor on page 18.



# **PACKAGE INFORMATION**

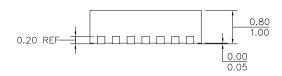
# QFN-16 (3mmx3mm)



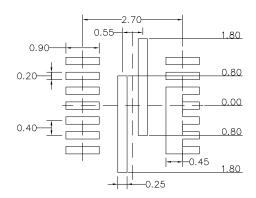


## **TOP VIEW**

**BOTTOM VIEW** 



## **SIDE VIEW**



# **RECOMMENDED LAND PATTERN**

# **NOTE:**

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) LEAD COPLANARITY SHALL BE 0.10 MILLIMETERS MAX.
- 3) JEDEC REFERENCE IS MO-220.
- 4) DRAWING IS NOT TO SCALE.

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